

bq500212A Data Sheet Errata

These are the errata for the bq500212A Wireless Power Transmitter data sheet, <u>SLUSBD6</u>.

1 Erratum #1

Data sheet (SLUSBD6B) shows Pin 45 open in application circuit. PWR_UP Pin 45 must be pull to a voltage greater than 2 V for normal operation in Low Power Mode. A low or open at Pin 45 will result in an increase in the interval between pings of 500 mS.

Recommended configuration for Pin 45 to V33D at Pin 33.

This configuration applies to all version and date codes of the bq500212A. Updates will be made to the documentation.

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